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Single N-Channel 1.5 V Specified PowerTrench[®] MOSFET 20 V, 9.5 A, 23 m Ω

Features

- Max r_{DS(on)} = 23 mΩ at V_{GS} = 4.5 V, I_D = 9.5 A
- Max r_{DS(on)} = 29 mΩ at V_{GS} = 2.5 V, I_D = 8.0 A
- Max $r_{DS(on)}$ = 36 m Ω at V_{GS} = 1.8 V, I_D = 4.0 A
- Max r_{DS(on)} = 50 mΩ at V_{GS} = 1.5 V, I_D = 2.0 A
- HBM ESD protection level > 2.5 kV (Note 3)
- Low Profile-0.8 mm maximum in the new package MicroFET 2x2 mm
- Free from halogenated compounds and antimony oxides
- RoHS Compliant

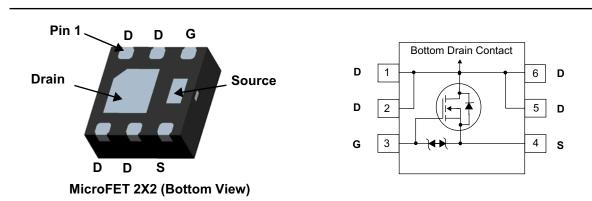


General Description

This Single N-Channel MOSFET has been designed using Fairchild Semiconductor's advanced Power Trench process to optimize the $r_{\rm DS(ON)}$ @ V_{\rm GS} = 1.5 V on special MicroFET leadframe.

Applications

- Li-lon Battery Pack
- Baseband Switch
- Load Switch
- DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parar	Ratings	Units			
V _{DS}	Drain to Source Voltage			20	V	
V _{GS}	Gate to Source Voltage			±8	V	
	-Continuous	T _A = 25 °C	(Note 1a)	9.5	A	
D	-Pulsed			24	A	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.4	14/	
	Power Dissipation $T_A = 25 \text{ °C}$ (Note 1b)			0.9	- W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/M
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	145	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
410	FDMA410NZ	MicroFET 2X2	7 "	8 mm	3000 units

June 2014

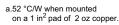
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		17		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±8 V, V _{DS} = 0 V			±10	μA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	0.4	0.7	1.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-3		mV/°C
		$V_{GS} = 4.5 \text{ V}, I_D = 9.5 \text{ A}$		17	23	mΩ
	Static Drain to Source On Resistance	$V_{GS} = 2.5 \text{ V}, I_D = 8.0 \text{ A}$		20	29	
r		V_{GS} = 1.8 V, I _D = 4.0 A		24	36	
r _{DS(on)}		V _{GS} = 1.5 V, I _D = 2.0 A		29	50	
		V _{GS} = 4.5 V, I _D = 9.5 A, T _J = 125 °C		23	32	
9 _{FS}	Forward Transconductance	V _{DD} = 5 V, I _D = 9.5 A		35		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 10 V, V _{GS} = 0 V,		815	1080	pF
C _{oss}	Output Capacitance			130	175	pF
C _{rss}	Reverse Transfer Capacitance			85	130	pF
R _g	Gate Resistance	f = 1 MHz		2.1		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			7.5	15	ns
t _r	Rise Time	V _{DD} = 10 V, I _D = 9.5 A, V _{GS} = 4.5 V, R _{GEN} = 6 Ω		3.9	10	ns
t _{d(off)}	Turn-Off Delay Time			27	44	ns
4(511) f	Fall Time			3.7	10	ns
Q _g	Total Gate Charge			10	14	nC
Q _{gs}	Gate to Source Charge	V _{GS} = 4.5 V , V _{DD} = 10 V, I _D = 9.5 A		1.2		nC
				2.0	1	nC

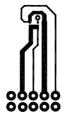
I _S	Maximum Continuous Drain-Source Diode Forward Current			2.0	A	
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 2.0 A (Note 2)		0.7	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 9.5 A, di/dt = 100 A/μs		12	22	ns
Q _{rr}	Reverse Recovery Charge	$T_F = 9.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		2.6	10	nC

NOTES:

1. $R_{0,JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{0,JC}$ is guaranteed by design while $R_{0,JA}$ is determined by the user's board design.

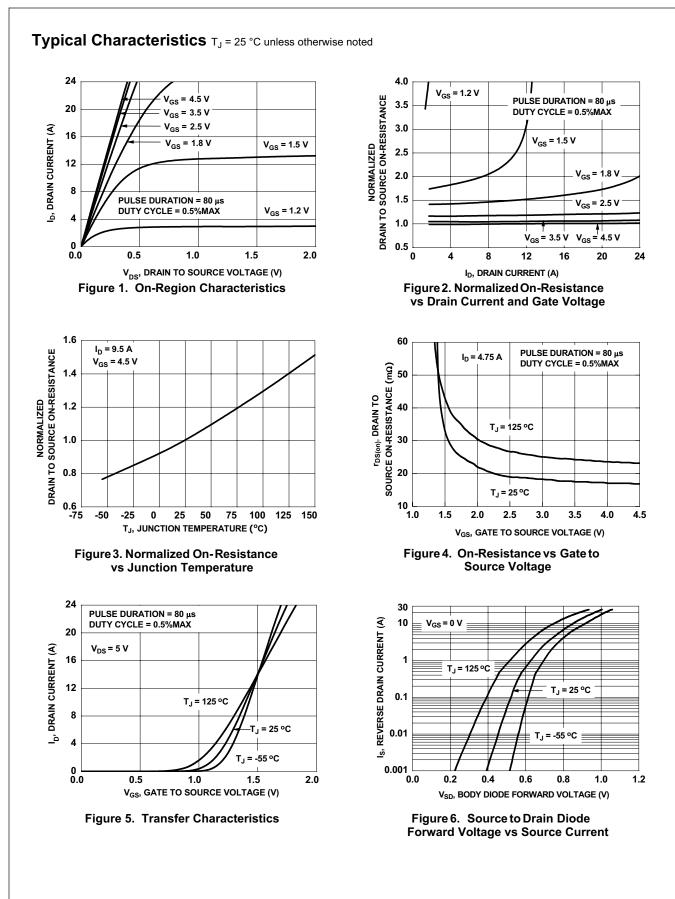




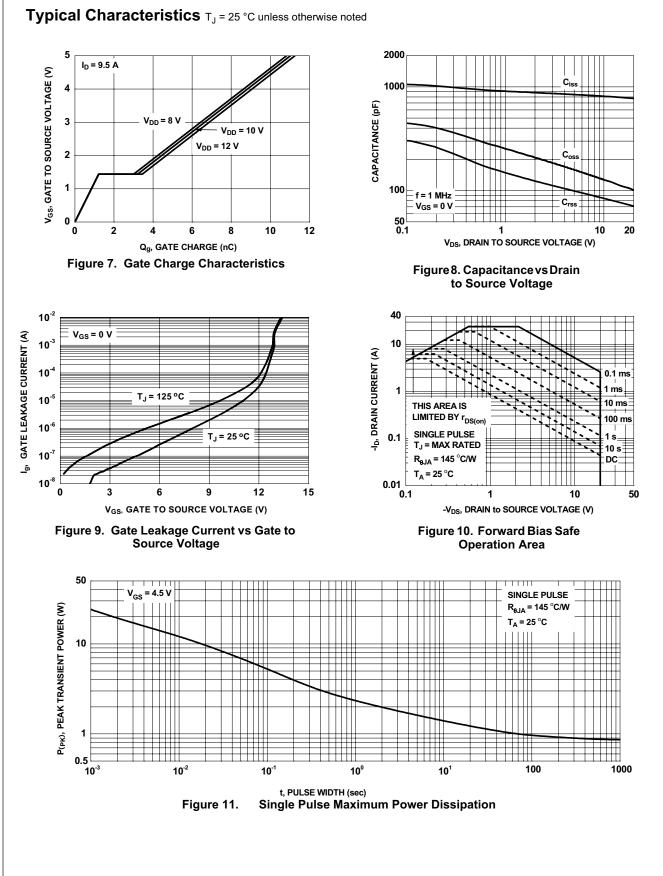


b. 145 °C/W when mounted on a minimum pad of 2 oz copper.

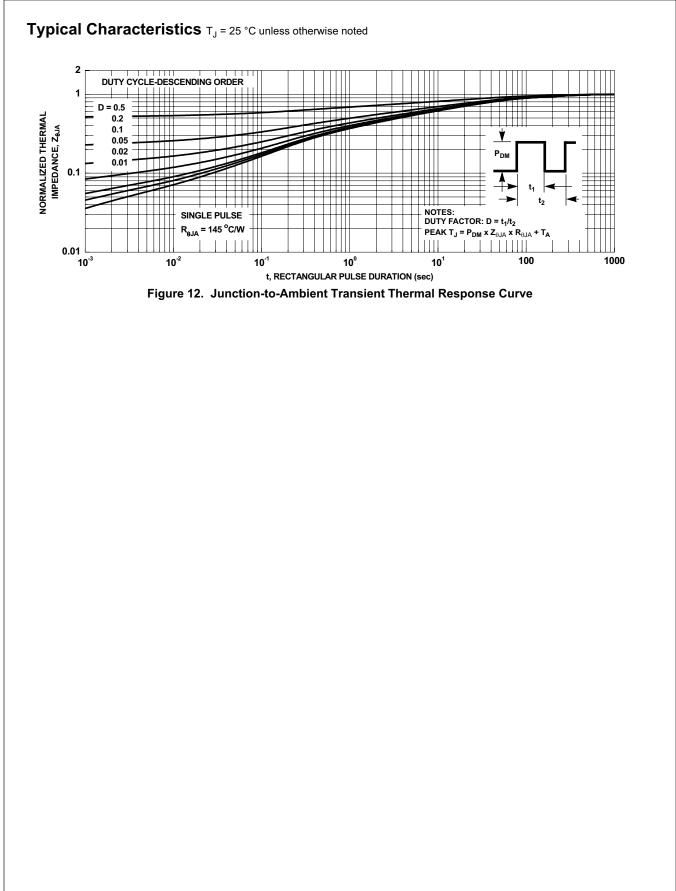
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

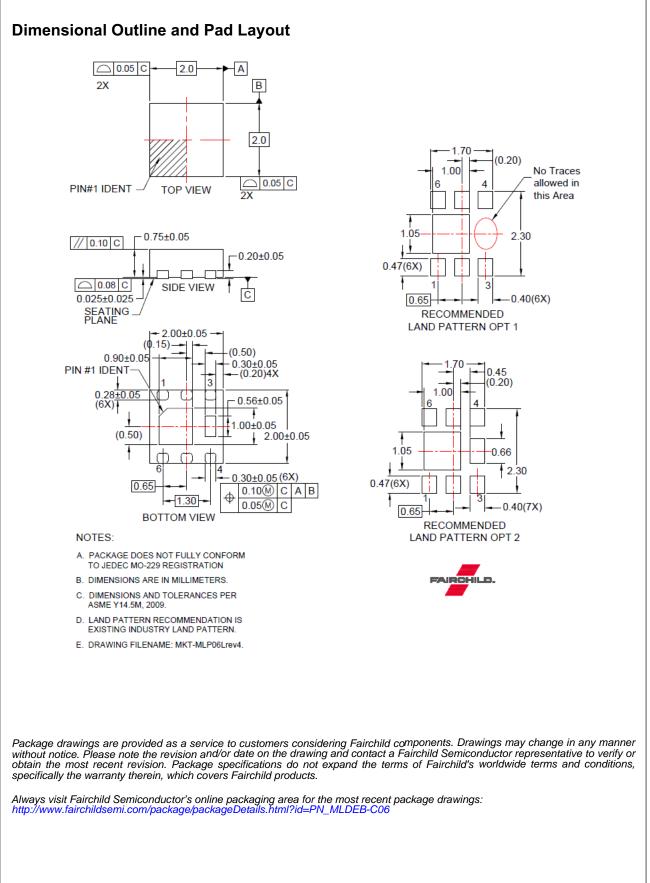


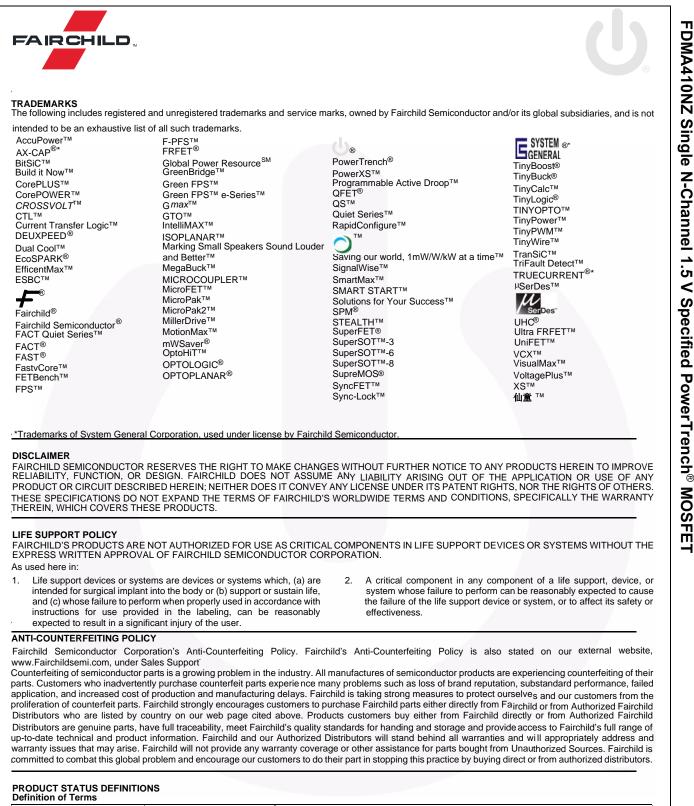
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FDMA410NZ Single N-Channel 1.5 V Specified PowerTrench® MOSFET







Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time withou notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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Телефон: 8 (812) 309 58 32 (многоканальный) **Факс:** 8 (812) 320-02-42 **Электронная почта:** <u>org@eplast1.ru</u> **Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.